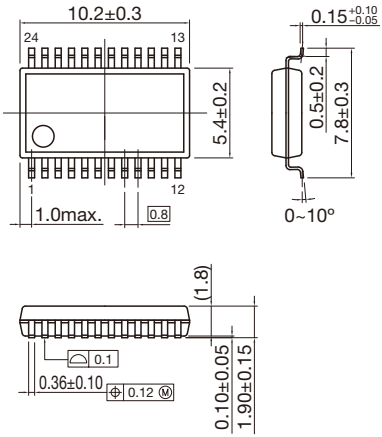
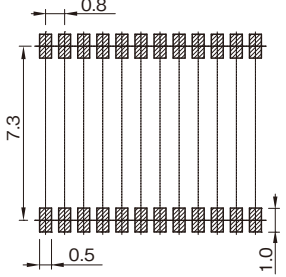
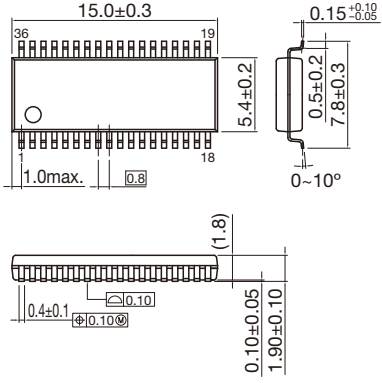
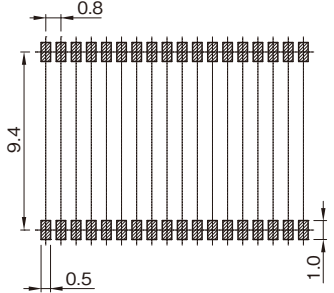


封装

封装名	外形尺寸图	推荐焊盘尺寸图
SSOP-24B	 SSOP-24B package dimensions (mm): - Width: 10.2 ± 0.3 - Height: 5.4 ± 0.2 - Pin pitch: 0.5 ± 0.2 - Pin width: $0.15^{+0.10}_{-0.05}$ - Lead angle: $0 \sim 10^\circ$ - Pin 1 indicator: 1.0 max. - Pin 12 location: 0.8 - Pin 1 location: 1.0 - Pin 12 location: 0.8 - Pin 1 location: 0.36 ± 0.10 - Pin 12 location: 0.12 - Pin 1 location: 0.10 ± 0.05 - Pin 12 location: 1.90 ± 0.15 - Pin 1 location: 0.1 - Pin 12 location: 0.1	 SSOP-24B recommended pad dimensions (mm): - Pad width: 0.8 - Pad pitch: 0.5 - Pad height: 1.0 - Pad length: 7.3
SSOP-36A	 SSOP-36A package dimensions (mm): - Width: 15.0 ± 0.3 - Height: 5.4 ± 0.2 - Pin pitch: 0.5 ± 0.2 - Pin width: $0.15^{+0.10}_{-0.05}$ - Lead angle: $0 \sim 10^\circ$ - Pin 1 indicator: 1.0 max. - Pin 18 location: 0.8 - Pin 1 location: 1.0 - Pin 18 location: 0.8 - Pin 1 location: 0.4 ± 0.1 - Pin 18 location: 0.10 - Pin 1 location: 0.10 ± 0.05 - Pin 18 location: 1.90 ± 0.10 - Pin 1 location: 0.1 - Pin 18 location: 0.1	 SSOP-36A recommended pad dimensions (mm): - Pad width: 0.8 - Pad pitch: 0.5 - Pad height: 1.0 - Pad length: 9.4